

RELIABILITY REPORT FOR

DS21354, Rev B2

Dallas Semiconductor

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Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products and processes:

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

```
AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts
AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10-5 eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
Ea = Activation Energy (e.g. 0.7 ev)
```

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

```
AfV = exp(B*(Vs - Vu))
AfV = Acceleration factor due to Voltage
Vs = Stress Voltage (e.g. 7.0 volts)
Vu = Maximum Operating Voltage (e.g. 5.5 volts)
B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)
```

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

```
Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size
```

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 9048 FITS: 12.6

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 5.5 Volts

The reliability data follows. A the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data.

Device Information:

Process: 8"-D6H-2P2M,HPVt,TCN1 ALOCOS:GOI Passivation: Passivation w/OxyNitride-Nov. 4% PSG

Die Size: 293 x 311 Number of Transistors: 172615

Interconnect: Aluminum / 1% Silicon / 0.5% Copper

Gate Oxide Thickness: 150 Å

ELECTRICAL CHARACTERIZATION						
DESCRIPTION	DATE COD	E CONDITION	REA	DPOINT	QUANTITY	FAILS
ESD SENSITIVITY	0336	EOS/ESD S5.1 HBM 500 VOLTS	1	PUL'S	3	0
ESD SENSITIVITY	0336	EOS/ESD S5.1 HBM 1000 VOLTS	1	PUL'S	3	0
ESD SENSITIVITY	0336	EOS/ESD S5.1 HBM 2000 VOLTS	1	PUL'S	3	0
ESD SENSITIVITY	0336	EOS/ESD S5.1 HBM 4000 VOLTS	1	PUL'S	3	0
ESD SENSITIVITY	0336	EOS/ESD S5.1 HBM 8000 VOLTS	1	PUL'S	3	3
LATCH-UP	0336	JESD78, I-TEST 125C			6	0
LATCH-UP	0336	JESD78, Vsupply TEST 125C			6	0
				To	tal:	3
OPERATING LIFE						
OPERATING LIFE DESCRIPTION	DATE COD	E CONDITION	REA	DPOINT	QUANTITY	FAILS
	DATE COD 0336	E CONDITION 125C, 5.25 VOLTS		DPOINT HRS	QUANTITY 77	FAILS 0
DESCRIPTION					77	
DESCRIPTION	0336) HRS	77	0
DESCRIPTION HIGH TEMP OP LIFE	0336 LE		1000) HRS To	77	0
DESCRIPTION HIGH TEMP OP LIFE TEMPERATURE CYC	0336 LE	125C, 5.25 VOLTS	1000) HRS To	77 tal:	0 0
DESCRIPTION HIGH TEMP OP LIFE TEMPERATURE CYC DESCRIPTION	0336 LE DATE COD	125C, 5.25 VOLTS E CONDITION	1000) HRS To	77 tal: QUANTITY 77	0 0 FAILS
DESCRIPTION HIGH TEMP OP LIFE TEMPERATURE CYC DESCRIPTION	0336 LE DATE COD 0336	125C, 5.25 VOLTS E CONDITION	1000	DPOINT CYS	77 tal: QUANTITY 77	0 0 FAILS
DESCRIPTION HIGH TEMP OP LIFE TEMPERATURE CYCLE DESCRIPTION TEMP CYCLE	0336 LE DATE CODE 0336 IDITY BIAS	125C, 5.25 VOLTS E CONDITION	1000 REA 1000	DPOINT CYS To	77 tal: QUANTITY 77	0 0 FAILS

Total: 0

UNBIASED MOISTURE RESISTANCE

DESCRIPTION DATE CODE CONDITION READPOINT QUANTITY FAILS

HAST, NO BIAS 0336 130C, 85% R.H. 200 HRS 77 0

Total: 0

FAILURE RATE: MTTF (YRS): 9048 FITS: 12.6